

SZSMF5.0AT1G Series







Maximum Ratings and Thermal Characteristics

Rating	Symbol	Value	Unit
Maximum Ppk Dissipation (PW-10/1000 μ s) (Note 1) SZSMF5.0A - SZSMF58A	P _{PK}	200	W
Maximum P_{PK} Dissipation @ $T_A = 25$ °C, (PW-8/20 μ s) (Note 2)	P _{PK}	1000	W
DC Power Dissipation @T _A = 25°C (Note 3)	PD	385	mW
Derate Above 25°C Thermal Resistance from Junction-to-Ambient (Note 3)	R _{eJA}	4.0 325	°C/W
Thermal Resistance, Junction-to-Lead (Note3)	R _{eJL}	26	°C/W
Operating and Storage Temperature Range	$T_{J_{J}}T_{stg}$	-55 to +150	°C

Stresses exceeding Maximum Ratings may damage the component. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect component reliability.

- 1. Non-repetitive current pulse at $T_A = 25^{\circ}$ C, per waveform of Figure 2.
- 2. Non-repetitive current pulse at T_Δ = 25°C, per waveform of Figure 3.
- 3. Mounted with recommended minimum pad size, DC board FR-4.
- 1/2 sine wave (or equivalent square wave), PW = 8.3 ms, duty cycle = 4 pulses per minute maximum.

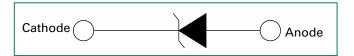
Description

The SZSMF series is designed to protect sensitive system or components from high voltage, high energy transients. It offers a fast response time, low Zener impedance, high surge capability and excellent clamping capability. Because of its small size, it is ideal for use in cellular phones, portable devices, business machines, power supplies and other industrial / consumer applications.

Features

- Stand-off Voltage: 5 58 Volts
- Peak Power 200 Watts @ 1 ms SZSMF5.0AT1G-SZSMF58AT1G
- · Low Leakage
- Response Time is Typically < 1 ns
- ESD Rating of Class 3 (> 16 kV) per Human Body Model
- ESD Rating of Level 4 (8 kV Contact Discharge) per IEC 61000-4-2
- EFT (Electrical Fast Transients) Rating of 40 A per IEC 61000-4-4
- Low Profile Maximum Height of 1.0 mm
- Small Footprint Footprint Area of 8.45 mm2
- Supplied in 8 mm Tape and Reel 3,000 Units per Reel
- Cathode Indicated by Polarity Band
- Lead Orientation in Tape: Cathode Lead to Sprocket Holes
- These components are Pb-Free and are RoHS Compliant
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable

Functional Diagram



Additional Information







Sample



Electrical Characteristics ($T_1 = 30$ °C unless otherwise noted, $V_F = 1.25$ Volts @ 200 mA)

Device	Device	V _{RWM} V _{BR} @ I _T (V) (Note 6)			@ I _т	I _R @ V _{RWM}	V _c (Max)	I _{PP} (Max) (A)	
Device	Marking	V	Min	Nom	Max	mA	(µA)	(V)	(Note 7)
SZSMF5.0AT1G	KE	5	6.4	6.7	7.0	10	400	9.2	21.7
SZSMF6.0AT1G	KG	6	6.67	7.02	7.37	10	400	10.3	19.4
SZSMF6.5AT1G	KK	6.5	7.22	7.60	7.98	10	250	11.2	17.9
SZSMF7.0AT1G	KM	7	7.78	8.19	8.6	10	100	12	16.7
SZSMF7.5AT1G	KP	7.5	8.33	8.77	9.21	1	50	12.9	15.5
SZSMF8.0AT1G	KR	8	8.89	9.36	9.83	1	25	13.6	14.7
SZSMF9.0AT1G	KV	9	10	10.55	11.1	1	5	15.4	13.0
SZSMF10AT1G	KX	10	11.1	11.7	12.3	1	2.5	17	11.8
SZSMF11AT1G	KZ	11	12.2	12.85	13.5	1	2.5	18.2	11.0
SZSMF12AT1G	LE	12	13.3	14	14.7	1	2.5	19.9	10.1
SZSMF13AT1G	LG	13	14.4	15.15	15.9	1	1	21.5	9.3
SZSMF14AT1G	LK	14	15.6	16.4	17.2	1	1	23.2	8.6
SZSMF15AT1G	LM	15	16.7	17.6	18.5	1	1	24.4	8.2
SZSMF18AT1G	LT	18	20	21	22.1	1	1	29.2	6.8
SZSMF20AT1G	LV	20	22.2	23.35	24.5	1	1	32.4	6.2
SZSMF22AT1G	LX	22	24.4	25.6	26.9	1	1	35.5	5.6
SZSMF24AT1G	LZ	24	26.7	28.1	29.5	1	1	38.9	5.1
SZSMF26AT1G	ME	26	28.9	30.4	31.9	1	1	42.1	4.8
SZSMF28AT1G	MG	28	31.1	32.8	34.4	1	1	45.4	4.4
SZSMF30AT1G	MK	30	33.3	35.1	36.8	1	1	48.4	4.1
SZSMF33AT1G	ММ	33	36.7	38.7	40.6	1	1	53.3	3.8
SZSMF36AT1G	MP	36	40	42.1	44.2	1	1	58.1	3.4
SZSMF48AT1G	MX	48	53.3	56.1	58.9	1	1	77.4	2.6
SZSMF58AT1G	NG	58	64.4	67.8	71.2	1	1	93.6	2.1

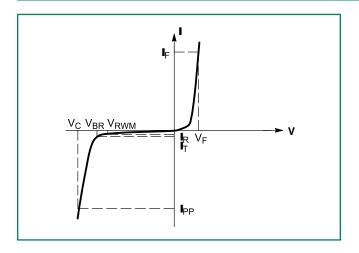
^{5.} A transient suppressor is normally selected according to the Working Peak Reverse Voltage (V_{RMM}) which should be equal to or greater than the DC or continuous peak operating voltage level.

^{6.} V_{BB} measured at pulse test current I_T at ambient temperature of 25°C.

^{7.} Surge current waveform per Figure 2 and derate per Figure 3.



I-V Curve Characteristics (T_A = 25°C unless otherwise noted, V_F = 3.5 V Max. @ I_F (Note 4) = 12 A)



Symbol	Parameter
I _{PP}	Maximum Reverse Peak Pulse Current
V _C	Clamping Voltage @ I _{PP}
V _{RWM}	Working Peak Reverse Voltage
I _R	Maximum Reverse Leakage Current @ V _{RWM}
V _{BR}	Breakdown Voltage @ I _T
I _T	Test Current
I _F	Forward Current
V _F	Forward Voltage @ I _F

Ratings and Characteristic Curves

Figure 1. Pulse Rating Curve

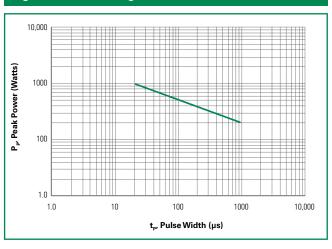


Figure 2. 10/1000 µs Pulse Waveform

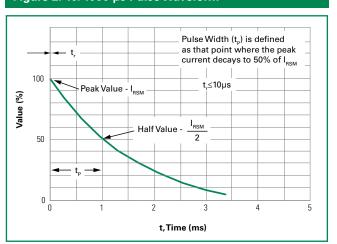


Figure 3. 8/20 µs Pulse Waveform

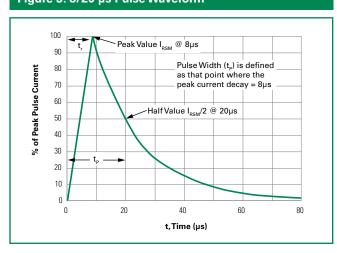


Figure 4. Pulse Derating Curve

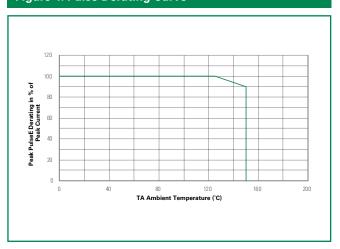
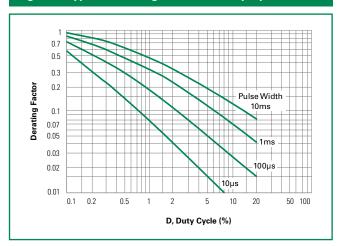




Figure 5. Typical Derating Factor for Duty Cycle



(u) uojte dissipation (u) uojte dissipation

Figure 6. Steady State Power Derating

Figure 7. Forward Voltage

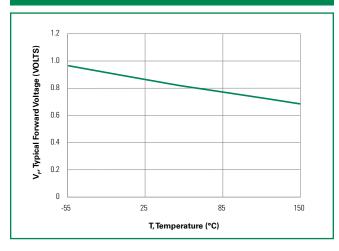
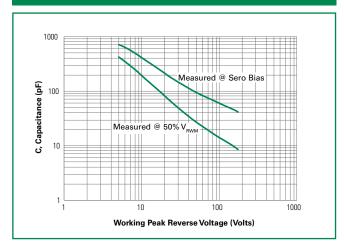


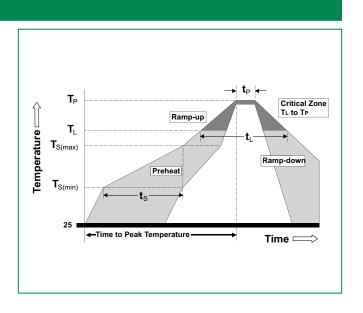
Figure 8. Capacitance vs. Working Peak Reverse Voltage

T, Temperature (°C)



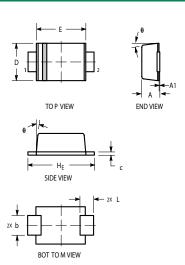
Soldering Parameters

Reflow Condition		Pb – Free assembly	
	-Temperature Min (T _{s(min)})	150°C	
Pre Heat	-Temperature Max (T _{s(max)})	200°C	
	-Time (min to max) (t _s)	60 – 120 secs	
Average ramp up rate (Liquidus) Temp (T _L) to peak		3°C/second max	
T _{S(max)} to T _L - Ramp-up Rate		3°C/second max	
Reflow	-Temperature (T _L) (Liquidus)	217°C	
	- Temperature (t _L)	60 – 150 seconds	
Peak Temperature (T _p)		260+0/-5 °C	
Time within 5°C of actual peak Temperature (t _p)		30 Seconds Max	
Ramp-down Rate		6°C/second max	
Time 25°C to peak Temperature (T _p)		8 minutes Max.	
Do not exc	eed	260°C	





Dimensions

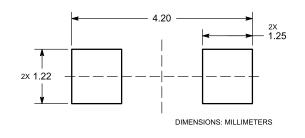


6.	Millimeters			Inches		
Dim	Min	Nom	Max	Min	Nom	Max
А	0.90	0.95	0.98	0.035	0.037	0.039
A1	0.00	0.05	0.10	0.000	0.002	0.004
b	0.70	0.90	1.10	0.028	0.035	0.043
С	0.10	0.15	0.20	0.004	0.006	0.008
D	1.50	1.65	1.80	0.059	0.065	0.071
Е	2.50	2.70	2.90	0.098	0.106	0.114
L	0.55	0.75	0.95	0.022	0.030	0.037
H _E	3.40	3.60	3.80	0.134	0.142	0.150
θ	0°	_	8°	0°	_	8°

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER.
- 3. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH.
- 4. DIMENSIONS D AND J ARE TO BE MEASURED ON FLAT SECTION OF THE LEAD: BETWEEN 0.10 AND 0.25 MM FROM THE LEAD TIP.

Soldering Footrpint



Ordering Information

Device	Package	Shipping†
SZSMFxxxAT1G	SOD-123FL (Pb-Free)	3,000 / Tape & Reel

Part Marking System



XXXX = Device Code (Max four Digits)

Y =Year M =Month

A =Assembly Location

ww =Lot Code



Tape and Reel Specification

